

RCE/2800

PTO/SB/30 (10/2001)

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REQUEST FOR CONTINUED EXAMINATION (RCE) TRANSMITTAL

Address to:
Commissioner for Patents
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Washington, DC 20231

Application Number	09/737,397
Filing Date	December 15, 2000
First Named Inventor	Yasuaki Tsuchiya
Art Unit	2822
Examiner Name	Maria Guerrero
Attorney Docket Number	14162

This is a Request for Continued Examination (RCE) under 37 CFR 1.114 of the above-identified application
Request for Continued Examination (RCE) practice under 37 CFR 1.114 does not apply to any utility or plant application filed prior to June 8,

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1. Submission required under 37 CFR §1.114

- a. ☐ Previously submitted
- i. ☐ Consider the amendment(s)/reply under 37 CFR §1.116 previously filed on _____
(Any unentered amendment(s) referred to above will be entered).
- ii. ☐ Consider the arguments in the Appeal Brief or Reply Brief previously filed on _____
- iii. ☐ Other _____
- b. ☒ Enclosed
- i. ☒ Amendment/Reply
- ii. ☐ Affidavit(s)/Declaration(s)
- iii. ☒ Information Disclosure Statement (IDS)
- iv. ☐ Other _____

2. Miscellaneous

- a. ☐ Suspension of action on the above-identified application is requested under 37 CFR §1.103(c) for a period of _____ months (Period of suspension shall not exceed 3 months; Fee under 37 CFR §1.17(i) required)
- b. ☐ Other _____

3. Fees

The RCE fee under 37 CFR §1.17(e) is required by 37 CFR §1.114 when the RCE is filed.

- a. ☒ The Director is hereby authorized to charge the following fees, or credit any overpayments, to Deposit Account No. 19-1013/SSMP
- i. ☒ RCE fee required under 37 CFR §1.17(e) \$ 750-
- ii. ☐ Extension of time fee (37 CFR §§1.136 and 1.17) 03/03/2003 AMONDAF1 00000011 191013 09737397
- iii. ☐ Other 01 FC:1001 750.00 CH
- b. ☐ Check in the amount of \$ _____ enclosed
- c. ☐ Payment by credit card (Form PTO-2038 enclosed)

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SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT REQUIRED

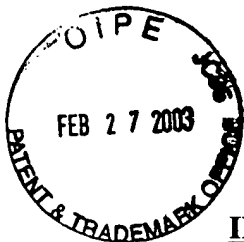
Name (Print / Type)	Mark J. Cohen	Registration No. (Attorney / Agent)	32,211
Signature	<i>Mark J. Cohen</i>	Date	February 19, 2003

CERTIFICATE OF MAILING OR TRANSMISSION

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Name (Print / Type)	Lisa Fiumara	Date	February 19, 2003
Signature	<i>Lisa Fiumara</i>		

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

PATENT

#12/B
3/6/03

Applicant(s): Yasuaki Tsuchiya, et al.

Examiner: Maria Guerrero

Serial No.: 09/737, 397

Art Unit: 2822

Filed: December 15, 2000

Docket: 14162

For: PROCESS FOR FORMING A METAL
INTERCONNECT

Dated: February 19, 2003

Assistant Commissioner for Patents
Washington, D.C. 20231

AMENDMENT

Sir:

In response to the Office Action dated November 19, 2002, applicants submit the following amendment for entry in the above-identified case.

IN THE CLAIMS:

Please cancel Claims 2 and 8 without prejudice.

Please amend Claims 1, 3, 5, 6, 9 and 12 as follows:

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1. (Amended) A process for forming a metal interconnect comprising the steps of forming a concave in an insulating film formed on a substrate, forming a barrier metal film on the insulating film, forming an interconnect metal film over the whole surface such that the concave is filled with the metal and then polishing the surface of the substrate by chemical

CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8(a)

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Dated: February 19, 2003

Lisa Fiumara
Lisa Fiumara

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